

Title (en)  
Kit of parts, method of producing and use thereof

Title (de)  
Kits aus Teilen, Herstellungsverfahren und Verwendung davon

Title (fr)  
Kit de pièces, procédé de fabrication et utilisation correspondante

Publication  
**EP 2412361 A1 20120201 (EN)**

Application  
**EP 10171184 A 20100729**

Priority  
EP 10171184 A 20100729

Abstract (en)  
The invention relates to a kit of parts comprising part A and part B, part A comprising a polymerizable component having an acid group in the molecule, an initiator, part B comprising an activator, and a film former. The invention also relates to a composition obtainable by mixing the components contained in the kit of parts and to a process for producing the kit of parts comprising the steps of bringing the components contained in part B of the kit in contact with a surface, drying the surface to form a film.

IPC 8 full level  
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**A61C 5/30** (2017.01 - EP US); **A61C 5/50** (2017.01 - EP US); **A61C 5/70** (2017.01 - EP US); **A61C 7/16** (2013.01 - US); **A61C 13/26** (2013.01 - US); **A61C 19/00** (2013.01 - US); **A61C 19/005** (2013.01 - EP US); **A61K 6/20** (2020.01 - EP US); **A61K 6/30** (2020.01 - EP US); **A61K 6/60** (2020.01 - EP US); **A61K 6/887** (2020.01 - EP US); **A61K 6/889** (2020.01 - EP US); **A61K 6/891** (2020.01 - EP US)

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Designated contracting state (EPC)  
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO SE SI SK SM TR

Designated extension state (EPC)  
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DOCDB simple family (publication)

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